



Switching Diode  
BAV70

## BAV70

Silicon epitaxial planar type

For high speed switching circuits  
Panasonic parts No. DA3Y103E

### ■ Features

- Short reverse recovery time trr
- Low terminal capacitance Ct
- Halogen-free / RoHS compliant  
(EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

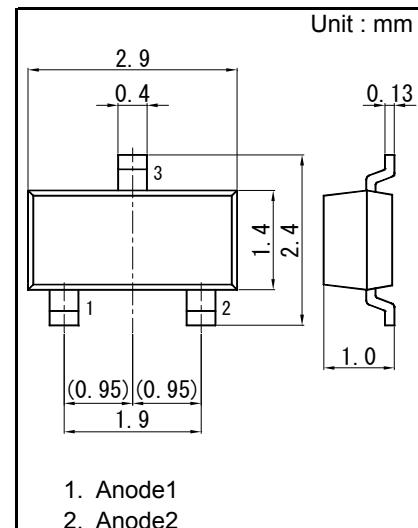
### ■ Marking Symbol: A4

### ■ Basic Part Number :

2 elements cathode-common type

### ■ Packaging

Embossed type (Thermo-compression sealing) : 3 000 pcs / reel (standard)



1. Anode1
2. Anode2
3. Cathode1,2

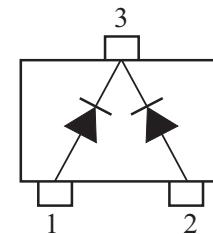
Panasonic	NMini3-R1-B
JEITA	SC-59A
Code	TO-236AA/SOT-23

### ■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit
Reverse voltage	VR	80	V
Maximum peak reverse voltage	VRM	80	V
Forward current	IF	200	mA
Non-repetitive peak forward surge current <sup>1)</sup>	IFSM	500	mA
Junction temperature	T <sub>j</sub>	150	°C
Operating ambient temperature	T <sub>opr</sub>	-40 to +85	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

Note) \*1 t = 1 s

### Internal Connection



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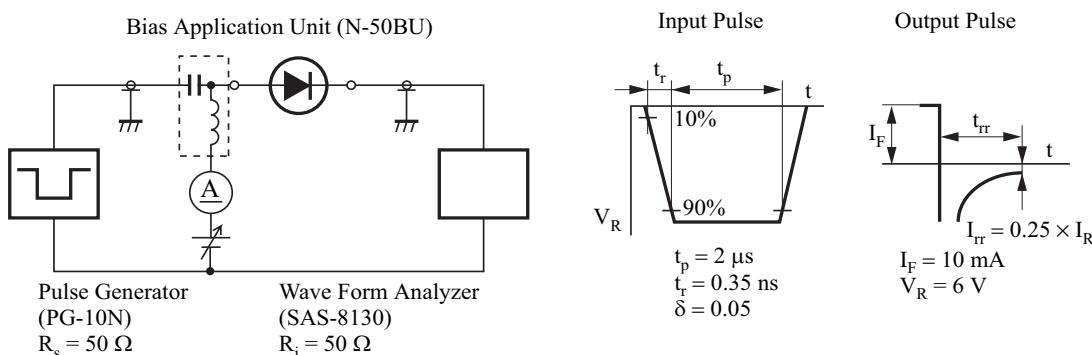
## ■ Electrical Characteristics $T_a = 25 \text{ }^{\circ}\text{C} \pm 3 \text{ }^{\circ}\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Forward voltage	VF	IF = 150 mA			1.25	V
Reverse voltage	VR	IR = 100 $\mu\text{A}$	80			V
Reverse current	IR	VR = 80 V			100	nA
Terminal capacitance	Ct	VR = 0 V, f = 1 MHz		2	15	pF
Reverse recovery time <sup>*1</sup>	trr	IF = 10mA, VR = 6V Irr = 0.25 $\times$ IR		2	10	ns

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.

2. Absolute frequency of input and output is 100 MHz.

3. <sup>\*1</sup> trr test circuit

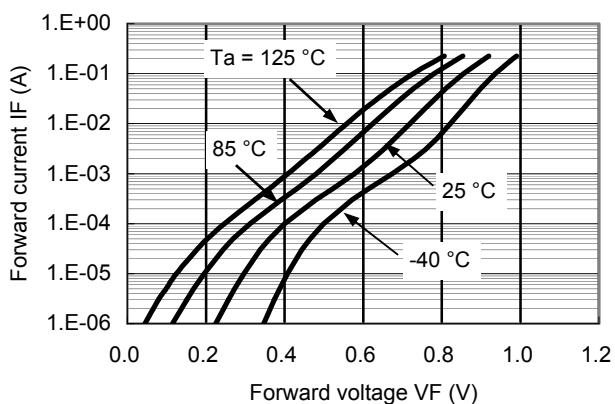




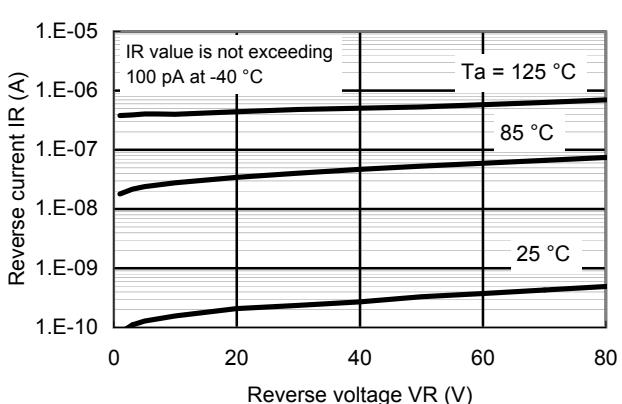
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### Technical Data ( reference )

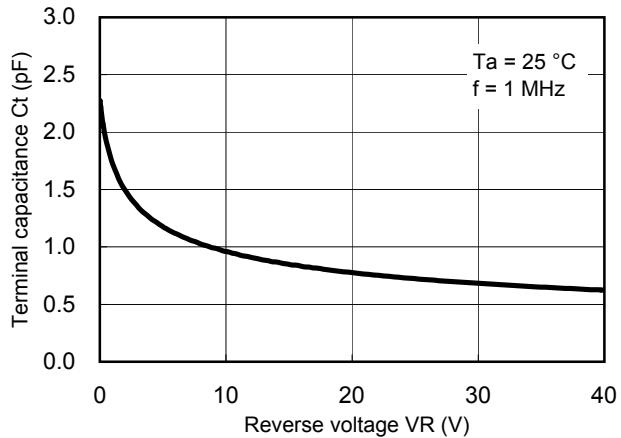
IF - VF



IR - VR



C<sub>t</sub> - VR

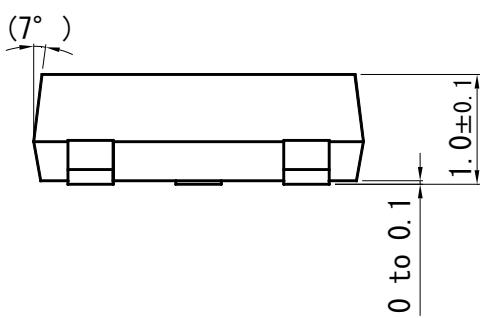
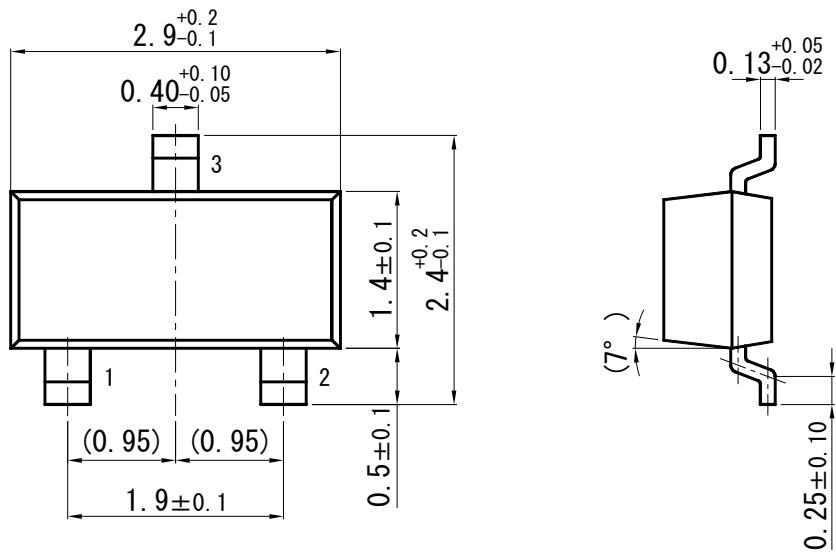


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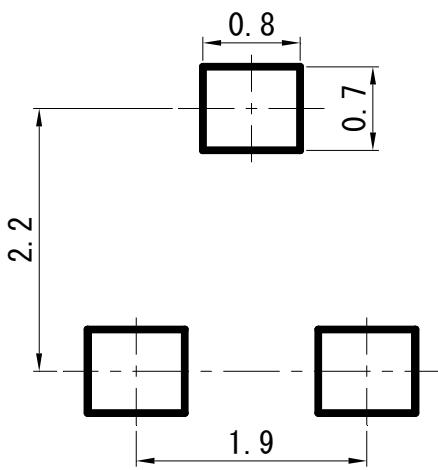
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**NMini3-R1-B**

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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